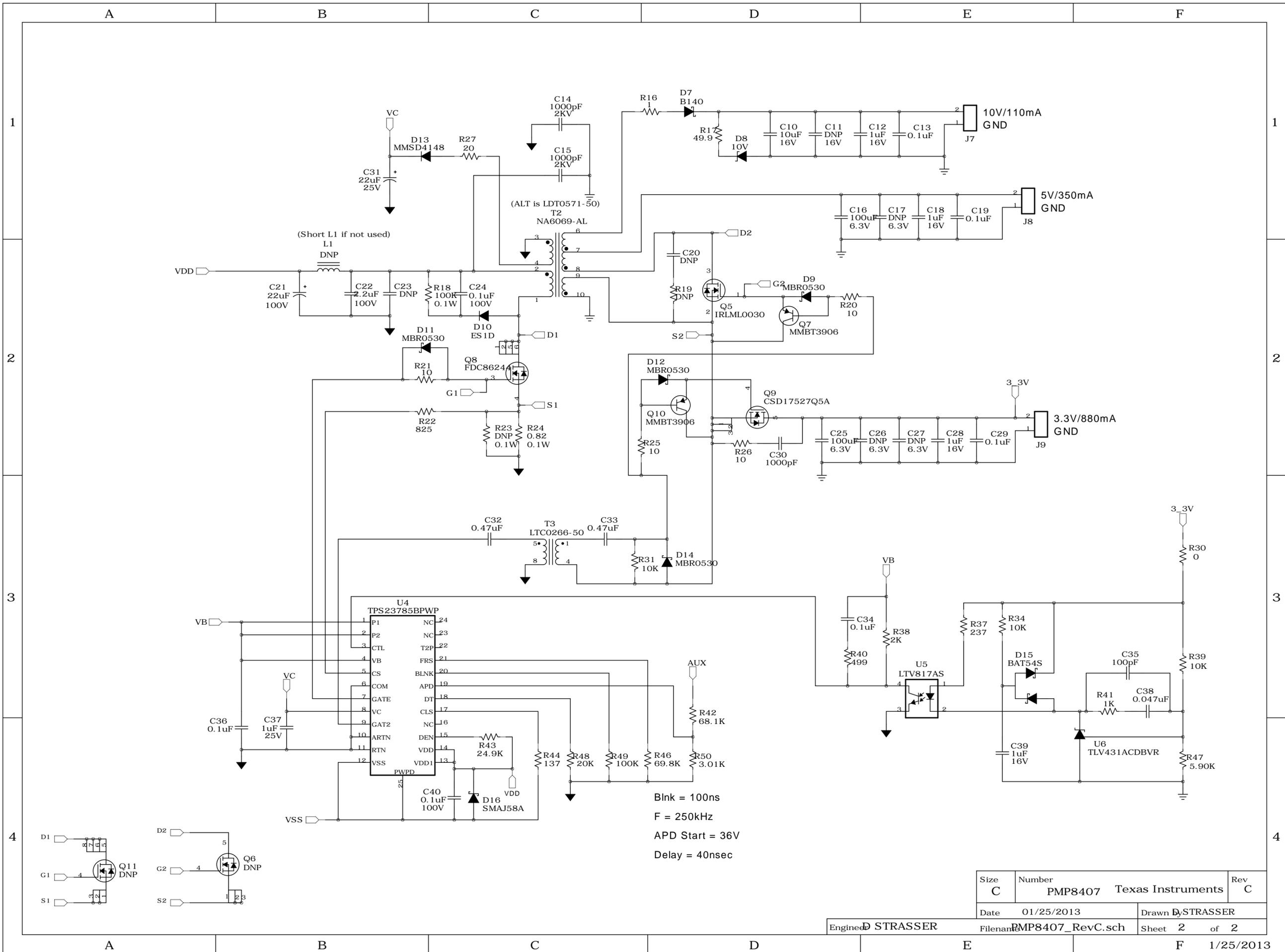


Title ISOLATED CLASS 2 POE CONVERTER			
Size C	Number PMP8407	Texas Instruments	Rev C
Date 01/25/2013	Drawn by STRASSER		
Engineer STRASSER	Filename PMP8407_RevC.sch	Sheet 1	of 2



Blnk = 100ns  
 F = 250kHz  
 APD Start = 36V  
 Delay = 40nsec

Size C	Number PMP8407	Texas Instruments	Rev C
Date 01/25/2013	Drawn by STRASSER		
Engineered by STRASSER		Filename PMP8407_RevC.sch	Sheet 2 of 2

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